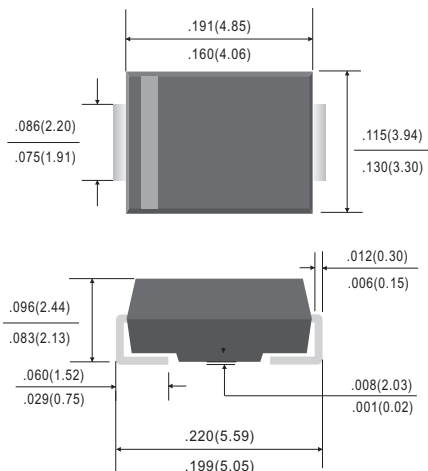


**3.0 Amp Glass Passivated Super Fast Rectifiers - 50~1000Volts**

**SMB Package**



**SMB(DO-214AA)**



Dimensions in inches and (millimeters)

**Features**

- Glass Passivated Chip
- Ideal for surface mounted applications
- Low leakage current
- Metallurgic ally bonded construction
- Moisture Sensitivity Level 1
- RoHS product for packing code suffix "G"  
Halogen free product for packing code suffix "H"

**Mechanical Date**

- Case: Molded Plastic, SMB(DO214AA)
- Epoxy: UL 94V-0 Rate Flame Retardant
- Lead: Solderable per MIL-STD-202, method 208 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.004 ounce, 0.104 gram (Approximate)

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half wave, 60Hz, resistive of inductive load.

For capacitive load, derate current by 20%

RATING		SYMBOLS	FM301B	FM302B	FM303B	FM304B	FM305B	FM306B	FM307B	UNITS	
<b>Marking code</b>			3B1	3B2	3B3	3B4	3B5	3B6	3B7		
Maximum Recurrent Peak Reverse Voltage		$V_{RRM}$	50	100	200	400	600	800	1000	<b>Volts</b>	
Maximum RMS Voltage		$V_{RMS}$	35	70	140	280	420	560	700	<b>Volts</b>	
Maximum DC Blocking Voltage		$V_{DC}$	50	100	200	400	600	800	1000	<b>Volts</b>	
Maximum Average Forward rectifier Current 0.375" (9.5mm) Lead length at Fig.1		$I_{F(AV)}$	3.0								<b>Amps</b>
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)		$I_{FSM}$	100								<b>Amps</b>
Maximum Instantaneous Forward Voltage at 3.0A DC		$V_F$	1.1								<b>Volts</b>
Maximum DC Reverse Current at Rated DC Blocking Voltage	@ Ta=25°C	$I_R$	5.0								$\mu A$
	@ Ta=100°C		100								
Typical Thermal Resistance (Note 2)		$R_{\theta JA}$	40								$^{\circ}C/W$
		$R_{\theta JC}$	15								
Typical Junction Capacitance(Note 1)		$C_J$	60								<b>pF</b>
Operating and Storage Temperature Range		$T_J, T_{STG}$	-55 ~ 150								$^{\circ}C$

**Notes:**

1. Measured at 1MHz and applied reverse voltage of 4.0VDC.
2. Thermal Resistance junction to ambient, 10.0\*10.0 mm<sup>2</sup> copper pads to each terminal.  
Thermal Resistance junction to case, 10.0\*10.0 mm<sup>2</sup> copper pads to each terminal.

**RATING AND CHARACTERISTICS CURVES**

FIG. 1 - TYPICAL FORWARD CURRENT DERATING CURVE

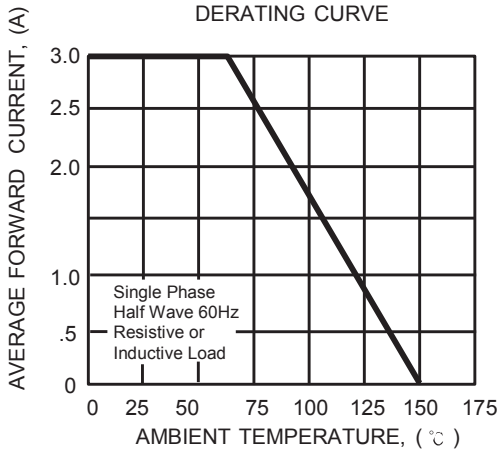


FIG. 2 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

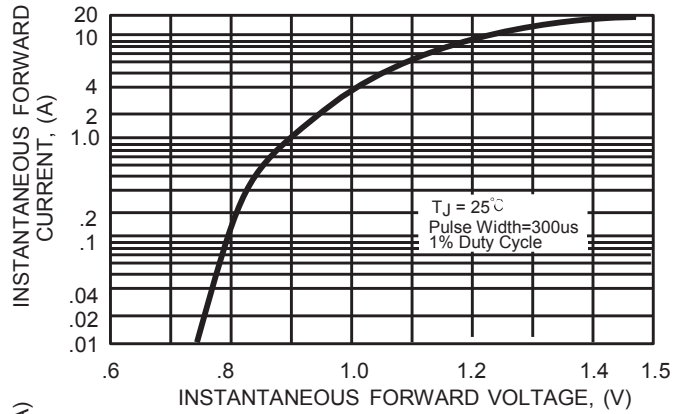


FIG. 3 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

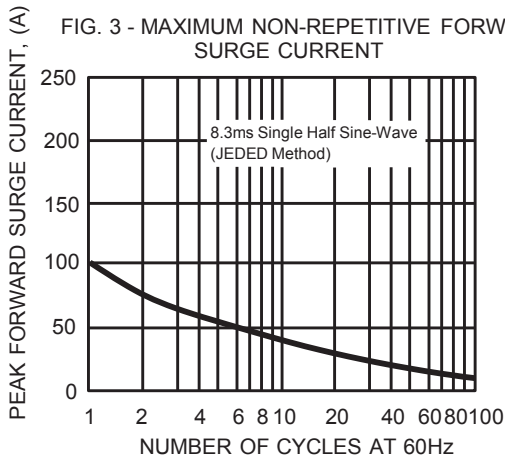


FIG. 4 - TYPICAL REVERSE CHARACTERISTICS

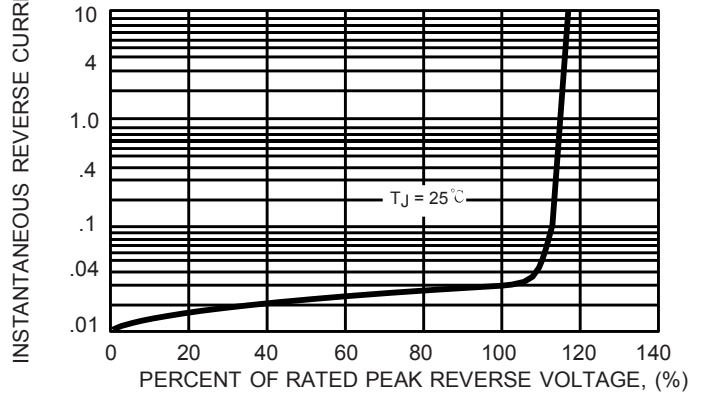


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

